

MC9328MX1

i.MX Integrated Portable System Processor

The i.MX family builds on the best-selling DragonBall family of application processors. Continuing this legacy, the DragonBall MX (Media Extensions) series provides a leap in performance with an ARM9™ microprocessor core and highly integrated system functions. i.MX products specifically address the requirements of the personal, portable product market by providing intelligent integrated peripherals, an advanced processor core, and power management capabilities.

The new MC9328MX1 features the advanced and power-efficient ARM920T™ core that operates at speeds up to 200 MHz. Integrated modules such as an LCD controller, static RAM, USB support, an A/D converter (with touch panel control), and an MMC/SD host controller offer a suite of peripherals to enhance any product seeking to provide a rich multimedia experience. In addition, the MC9328MX1 is the first Bluetooth™ technology-ready applications processor. It is packaged in a 256-pin Mold Array Process-Ball Grid Array (MAPBGA). The MC9328MX1 provides the following benefits:

- Represents the fifth generation of the industry-leading DragonBall family of microprocessors for the personal, portable product market

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- Features a high level of on-chip integration
- Provides uncompromising performance in a very low-power system design
- Optimized for multimedia applications
- Optimized for Bluetooth applications with high-speed interfaces to external Bluetooth solutions
- Supports a wide variety of applications including the most popular PDA designs, smart phones, and next-generation wireless communicators

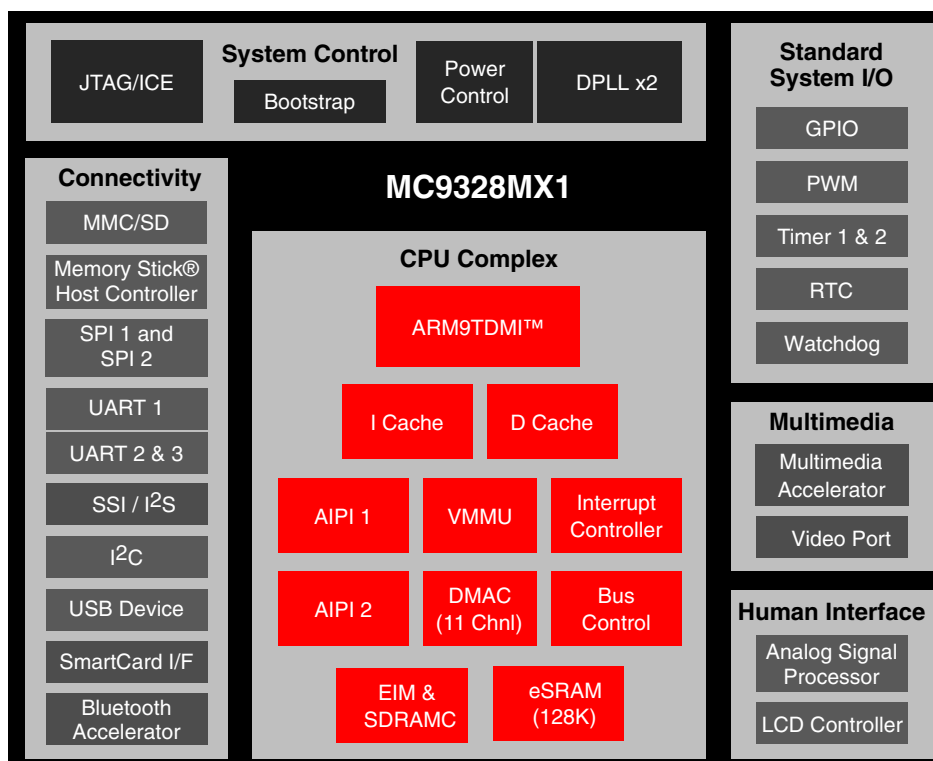


Figure 1. MC9328MX1 Functional Block Diagram

1 Features

To support a wide variety of applications, the MC9328MX1 boasts a robust array of features, including the following:

- ARM920T Microprocessor Core
- AHB to IP Bus Interfaces (APIs)
- External Interface Module (EIM)
- SDRAM Controller (SDRAMC)
- DPLL Clock and Power Control Module
- Three Universal Asynchronous Receiver/Transmitters (UART 1, UART 2, and UART 3)
- Two Serial Peripheral Interfaces (SPI1 and SPI2)
- Two General-Purpose 32-bit Counters/Timers
- Watchdog Timer

- Real-Time Clock/Sampling Timer (RTC)
- LCD Controller (LCDC)
- Pulse-Width Modulation (PWM) Module
- Universal Serial Bus (USB) Device
- Multimedia Card and Secure Digital (MMC/SD) Host Controller
- Memory Stick® Host Controller (MSHC)
- SmartCard Interface Module (SIM)
- Direct Memory Access Controller (DMAC)
- Two Synchronous Serial Interfaces and Inter-IC Sound (SSI 1 and SSI 2/I²S) Module
- Inter-IC (I²C) Bus Module
- Video Port
- General-Purpose I/O (GPIO) Ports
- Bootstrap Mode
- Analog Signal Processing (ASP) Module
- Bluetooth Accelerator (BTA)
- Multimedia Accelerator (MMA)
- 256-pin MAPBGA Package

The following sections detail the features of the MC9328MX1's functional blocks.

1.1 ARM920T Microprocessor Core

The MC9328MX1 uses the ARM920T microprocessor core which has the following features:

- 200 MHz maximum processing speed
- 16K instruction cache and 16K data cache
- ARM9 high performance 32-bit RISC engine
- Thumb® 16-bit compressed instruction set for a leading level of code density
- EmbeddedICE™ JTAG software debug
- 100-percent user code binary compatibility with ARM7TDMI® processors
- ARM9TDMI® core, including integrated caches, write buffers, and bus interface units, provides CPU-cache transparency
- Advanced Microcontroller Bus Architecture (AMBA™) system-on-chip multi-master bus interface
- Flexible CPU and bus clocking relationships including asynchronous, synchronous, and single-clock configurations
- Cache locking to support mixed loads of real-time and user applications
- Virtual Memory Management Unit (VMMU)

1.2 AHB to IP Bus Interfaces (AIPs)

The MC9328MX1 AIPs provide a communication interface between the high-speed AHB bus and a lower-speed IP bus for slow slave peripherals.

1.3 External Interface Module (EIM)

The MC9328MX1 EIM features:

- Up to six chip selects for external devices, each with 16 Mbyte of address space (chip selects for ROM support a maximum of 32 Mbyte of address space)
- Programmable protection, port size, and wait states for each chip select
- Internal/external boot ROM selection
- Selectable bus watchdog counter
- Burst support for external AMD™ or Intel® flash with 32-bit data path
- Interrupt controller to handle a maximum of 63 interrupt sources
- Vectored interrupt capability with prioritization for 16 sources

1.4 SDRAM Controller (SDRAMC)

The MC9328MX1 SDRAMC features:

- Supports 4 banks of 64-, 128-, or 256-Mbit synchronous DRAMs
- Includes 2 independent chip-selects
 - Up to 64 Mbyte per chip-select
 - Up to four banks simultaneously active per chip-select
 - JEDEC standard pinout and operation
- Supports Micron SyncFlash® SDRAM-interface burst flash memory
 - Boot capability from $\overline{\text{CSD1}}$
- Supports burst reads of word (32-bit) data types
- PC100 compliant interface
 - 100 MHz system clock achievable with “-8” option PC100 compliant memories
 - single and fixed-length (8-word) word access
 - Typical access time of 8-1-1-1 at 100 MHz
- Software configurable bus width, row and column sizes, and delays for differing system requirements
- Built in auto-refresh timer and state machine
- Hardware supported self-refresh entry and exit which keeps data valid during system reset and low-power modes
- Auto-powerdown (clock suspend) timer

1.5 Clock Generation Module (CGM) and Power Control Module

The MC9328MX1 CGM and Power Control Module features:

- Digital phase-locked loops (PLLs) and clock controller for all internal clocks generation
- MCUPLL generates FCLK to the CPU from either a 32 kHz or 32.768 kHz
- System PLL generates the system clock and the 48 MHz clock for the USB from a 16 MHz or either a 32 kHz or 32.768 kHz
- Support for three power modes for different power consumption needs: run, doze, and stop

1.6 Three Universal Asynchronous Receiver/Transmitters (UART 1, UART 2, and UART 3)

The MC9328MX1 UARTs feature:

- Support for serial data transmit/receive operation: 7 or 8 data bits, 1 or 2 stop bits, and programmable parity (even, odd, or none)
- Programmable baud rates up to 1.00 MHz
- 32-byte FIFO on Tx and 32 half-word FIFO on Rx that support autobaud
- IrDA 1.0 support

1.7 Two Serial Peripheral Interfaces (SPI)

The MC9328MX1 SPIs feature:

- SPI 1 is master/slave configurable, SPI 2 is master only
- Up to 16-bit programmable data transfer
- 8×16 FIFO for both Tx and Rx data

1.8 Two General-Purpose 32-Bit Counters/Timers

The MC9328MX1 General-Purpose Counters/Timers feature:

- Automatic interrupt generation
- Programmable timer input/output pins
- Input capture capability with programmable trigger edge
- Output compare with programmable mode

1.9 Watchdog Timer

The MC9328MX1 Watchdog Timer features:

- Programmable time out of 0.5 s to 64 s
- Resolution of 0.5 s

1.10 Real-Time Clock/Sampling Timer (RTC)

The MC9328MX1 RTC features:

- 32.768 kHz or 32 kHz
- Full clock features: seconds, minutes, hours, and days
- Capable of counting up to 512 days
- Minute countdown timer with interrupt
- Programmable daily alarm with interrupt
- Sampling timer with interrupt
- Once-per-second, once-per-minute, once-per-hour, and once-per-day interrupts
- Interrupt generation for digitizer sampling or keyboard debouncing

1.11 LCD Controller (LCDC)

The MC9328MX1 LCDC features:

- Software programmable screen size (a maximum of 640×512 pixels) to support single (non-split) monochrome, color STN panels, and color TFT panels
- Support for 4 bpp (bits per pixel), 8 bpp, and 12 bpp for passive color panels
- Support for 4 bpp, 8 bpp, 12 bpp, and 16 bpp for TFT panels
 - Up to 256 colors out of a palette of 4096 for 8 bpp
 - True 64K color for 16 bpp
- In color STN mode, the maximum bit depth is 12 bpp
- In BW mode, the maximum bit depth is 4 bpp
- Up to 16 grey levels out of 16 palettes
- Capable of directly driving popular LCD drivers from manufacturers including Motorola, Sharp, Hitachi, and Toshiba
- Support for data bus width for 12- or 16-bit TFT panels
- Panel interface of 8-, 4-, and 2-bits, and a 1-bit wide LCD panel data bus for monochrome panels
- Direct interface to Sharp® 320×240 HR-TFT panel
- Support for logical operation between color hardware cursor and background
- Uses system memory as display memory
- LCD contrast control using 8-bit PWM
- Support for self-refresh LCD modules
- Hardware panning (soft horizontal scrolling)

1.12 Pulse-Width Modulation (PWM) Module

The MC9328MX1 PWM Module features:

- 4×16 FIFO to minimize interrupt overhead
- 16-bit resolution

- Sound and melody generation

1.13 Universal Serial Bus (USB) Device

The MC9328MX1 USB Device features:

- Compliant with *Universal Serial Bus Specification, revision 1.1*
- Up to six logical endpoints—see Table 1 on page 7
- Support for isochronous communications pipes
 - Frame match interrupt feature notifies the user when a specific USB frame occurs
 - For DMA access, the maximum packet size for the isochronous endpoint is restricted by the FIFO size of the endpoint
 - For programmed I/O, isochronous data packets range from 0 bytes to 1023 bytes
- Support for control, bulk, and interrupt pipes
 - Packet sizes are limited to 8, 16, 32, or 64 bytes
 - Maximum packet size depends on the FIFO size of the endpoint
- Support (via a register bit) for a remote wake-up feature
- Full-speed (12 MHz) operation
- Operation can be programmed for both bus-powered and self-powered mode

Table 1. Endpoint Configurations

Endpoint	Direction	Physical FIFO Size (Bytes)	Endpoint Configuration	Maximum Packet Size (Bytes)
0	IN and OUT	32	Control	32
1–5	IN or OUT	32 or 64 ¹	Control, interrupt, bulk, or isochronous	User configurable: 8, 16, 32, or 64 (depending on FIFO size)

¹FIFO1 and FIFO2 are 64 bytes each; FIFO3, FIFO4, and FIFO5 are 32 bytes each.

1.14 Multimedia Card and Secure Digital (MMC/SD) Host Controller

The MC9328MX1 MMC/SD Host Controller features:

- Compatible with the *MultiMediaCard System Specification* (SPI mode excluded), version 3.1
- Compatible to 1/4 bit with the *SD Memory Card Specification* (SPI mode excluded), version 1.0 and *SD I/O Specification* (SPI mode excluded), version 1.0 with 1 or 4 channel(s)
- Up to ten MMC cards and one SD are supported by standard (maximum data rate with a maximum of ten cards)
- Support for hot swappable operation
- Support for data rates from 20 Mbps to 80 Mbps

1.15 Memory Stick® Host Controller (MSHC)

The MC9328MX1 MSHC features:

- Integrated 8-byte (4-word) FIFO buffer for transmit and receive
- Integrated CRC circuit
- Support for internal or external serial clock source
- Integrated Serial Clock Divider
- DMA support; DMA request condition is selectable based on FIFO status
- Automatic command execution when an interrupt from the Memory Stick is detected (can be toggled on/off)
- RDY time-out period set by the number of serial clock cycles
- Interrupt output to the ARM920T core when a time-out occurs
- Two integrated general-purpose input pins for detecting Memory Stick insertion/extraction
- 16-bit host bus access (byte access not supported)

1.16 SmartCard Interface Module (SIM)

The MC9328MX1 SIM features:

- ISO7816 smartcard interface
- 32-word deep receive FIFO
- SIM card presence detect with interrupt capability

1.17 Direct Memory Access Controller (DMAC)

The MC9328MX1 DMAC features:

- 11 channels to support linear memory, 2D memory, FIFO, and End-of-Burst Enable FIFO for both source and destination
- Support for 8-, 16-, or 32-bit FIFO port size and memory port size data transfer
- Support for big-endian and little-endian
- Configurable DMA burst length for each channel up to 16 words, 32 half-words, or 64 bytes
- Bus utilization control for a channel that is not triggered by DMA requests
- Bulk data transfer complete or transfer error interrupts provided to interrupt handler (and then to the core)
- DMA burst time-out error terminates the DMA cycle when the burst cannot be completed within a programmed timing period
- Acknowledge signal provided to peripheral after DMA burst is complete

1.18 Synchronous Serial Interface and Inter-IC Sound (SSI/I²S) Module

The MC9328MX1 SSI/I²S Modules features:

- Supports generic SSI interface for external audio chip or interprocessor communication
- Supports Philips standard Inter-IC Sound (I²S) bus for external digital audio chip interface

1.19 Inter-IC (I²C) Bus Module

The MC9328MX1 I²C Bus Module features:

- Support for Philips I²C-bus standard for external digital control
- Support for 3.3 V tolerant devices
- Multiple-master operation
- Software-programmable for 1 of 64 different serial clock frequencies
- Software-selectable acknowledge bit
- Interrupt-driven, byte-by-byte data transfer
- Arbitration-lost interrupt with automatic mode switching from master to slave
- Calling address identification interrupt
- Start and stop signal generation and detection
- Repeated START signal generation
- Acknowledge bit generation and detection
- Bus-busy detection

1.20 Video Port

The MC9328MX1 video port supports external CMOS sensor video data input.

1.21 General-Purpose I/O (GPIO) Ports

The MC9328MX1 GPIO ports feature:

- Interrupt capability
- 110 total I/O pins multiplexed with most dedicated functions for pin efficiency

1.22 Bootstrap Mode

The MC9328MX1 Bootstrap Mode features:

- Allows user to initialize system and download program or data to system memory through UART
- Accepts execution command to run program stored in system memory
- Supports memory/register read/write operation of selectable data size of byte, half-word, or word
- Provides a 32-byte instruction buffer for ARM920T core vector table storage, instruction storage and execution

1.23 Analog Signal Processing (ASP) Module

The MC9328MX1 ASP Module features:

- Pen ADC
 - 9-bit Pen ADC (PADC) for touch panel and low voltage detection
 - 12 × 16-bit FIFO for PADC sample
 - Embedded touch panel circuitry
 - Supports auto and manual sampling mode
 - Programmable pen down and pen-up interrupt to interrupt handler
 - Provides data-ready and FIFO-full interrupt to interrupt handler
 - True differential input

1.24 Bluetooth Accelerator (BTA)

The MC9328MX1 Bluetooth Accelerator features:

- Low-level baseband processing engine
- Hop frequency selection co-processing module
- 32-word (16-bit) Rx and Tx buffer
- Programmable RF controller supports three front ends (including SPI / μ Wire controller)
- Support for external transceiver ICs from manufacturers such as Freescale (MC13180) and Silicon Wave™
- Bluetooth application timer
- Wake-up timer for low-power support
- Low-power capabilities

1.25 Multimedia Accelerator (MMA)

The MC9328MX1 Multimedia Accelerator features:

- MAC for FIR and FFT operation—MP3 applications save 10% to 15% CPU MIPS
- DCT/iDCT hardware accelerator—MPEG4 decode applications save approximately 10% CPU MIPS

1.26 Power Management Features

The MC9328MX1 provides the following power management features:

- Programmable clock synthesizer using either a 32 kHz or 32.768 kHz crystal for full frequency control
- Low-power stop capabilities
- Modules that can be individually shut down
- Lowest power mode control

1.27 Operating Voltage Range NOTES

The MC9328MX1 operating voltages are as follows:

- I/O voltage—1.70 V to 2.0 V or 2.7 V to 3.3 V
- Internal logic voltage—150 MHz: 1.70 V to 1.9 V; 200 MHz: 1.8 to 2.0V

1.28 Packaging

The MC9328MX1 features the package:

- 256-pin MAPBGA package with 14 mm × 14 mm × 1.3 mm, 0.8 mm ball pitch

1.29 Revision History

This revision is to update the document into the new Freescale look.

2 Reference Documents

MC9328MX1 Data Sheet (order number MC9328MX1/D)

MC9328MX1 Reference Manual (order number MC9328MX1RM/D)

The documents may be found at the Freescale Semiconductor Inc. World Wide Web site at <http://www.freescale.com/imx>. These documents may be downloaded directly from the World Wide Web site, or printed versions may be ordered. The World Wide Web site also may have useful application notes.

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